



ENTERPRISE D-SERIES

Data Center High-Speed Storage in M.2, E1.S and U.2 Form Factors

The D100 has enterprise SSD firmware optimized for data center applications that supports a high Quality of Service (QoS) in command execution completion times. Phison's business model is to customize the D100 Series SSD platform to our customers' unique application and brand requirements making the Enterprise SSD truly unique to each partner.



Product Features

- PCle 4.0 x4
- NVMe 1.4
- Capacity up to 3.84TB
- Form Factor: E1.S / U.2 / M.2 2280 / M.2 22110
- DWPD: 1
- 64 Namespaces
- Power Loss Protection (PLP)
- TCG Opal 2.0 Support
- AES-XTS 256-bit Encryption
- End-to-End Data Path Protection
- SECDED
- Sanitize
- NVMe-MI (Management Interface)
- SMBus

Sequential Performance

Read 6,800 MB/s

Write 2,000K MB/s

Random Performance

Read 900K IOPS

Write 60K IOPS



Form Factor		E1.S					
Capacity ⁽¹⁾	480GB	960GB	1920GB	3840GB			
Interface	PCle 4.0 x4	PCle 4.0 x4	PCle 4.0 x4	PCle 4.0 x4			
NVMe	1.4	1.4	1.4	1.4			
NAND Flash	3D TLC	3D TLC	3D TLC	3D TLC			
	Performance ^(2,3,4)						
Sequential Read(MB/s)	6,500	6,800	6,800	6,800			
Sequential Write(MB/s)	700	1,400	2,000	1,700			
4K Random Read(IOPS)	450K	800K	900K	650K			
4K Random Write(IOPS)	25K	50K	60K	70K			
Read Latency (Typ., μs)	75	75	75	80			
Write Latency (Typ., µs)	40	30	25	25			
Power Consumption ⁽⁵⁾							
Active (W)	9.5	10.5	13.5	12.5			
Idle (W)	4	4	4.2	4.2			
	Endura	nce/Reliability					
DWPD ⁽⁶⁾	1	1	1	1			
UBER	< 1 sector per 10 ¹⁷ bits read						
MTBF (million hours)	2.0	2.0	2.0	2.0			
Limited Warranty (years)	5	5	5	5			
Temperature							
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70	0 - 70			
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85	-40 - 85			
Physical Dimension							
Length (mm)	118.75	118.75	118.75	118.75			
Width (mm)	33.75	33.75	33.75	33.75			
Height (mm)	9.50	9.50	9.50	9.50			
Weight (g)	63	63	68	68			
Part Number							
Non-SED FW SED FW	D180AK02480GP015 12G00 D180AK02480GP215 12G00	D180AK02960GP011 T0200 D180AK02960GP211 T0200	D180AK021T92P012 T0400 D180AK021T92P212 T0400	D180AK023T84P014 T0900 D180AK023T84P214 T0900			



 ¹ TB = 10¹² bytes.
 Sequential Performance is based on FIO on Linux, 128K, with QD=32, 1 worker.
 Random Performance is based on FIO on Linux, 4K data size, QD=32, 8 worker.

⁽⁴⁾ Latency is measured with random workloads based on FIO on Linux, 4KB data size, QD=1, 1 worker.

⁽⁵⁾ Power consumption (Maximum RMS) is measured during the sequential read/write and random read/write operations performed by iometer with the conditions described in (2)(3).

(6) The results of DWPD are obtained in compliance with JESD219A Standards.

		11.2				
Form Factor		U.2				
Capacity ⁽¹⁾	480GB	960GB	1920GB			
Interface	PCIe 4.0 x4	PCIe 4.0 x4	PCIe 4.0 x4			
NVMe	1.4	1.4	1.4			
NAND Flash	3D TLC	3D TLC	3D TLC			
Performance ^(2,3,4)						
Sequential Read(MB/s)	6,500	6,800	6,800			
Sequential Write(MB/s)	700	1,400	2,000			
4K Random Read(IOPS)	450K	800K	900K			
4K Random Write(IOPS)	25K	50K	60K			
Read Latency (Typ., µs)	75	75	75			
Write Latency (Typ., µs)	35	20	20			
Power Consumption ⁽⁵⁾						
Active (W)	8.7	9.3	11.3			
Idle (W)	4	4	4.2			
	Endura	nce/Reliability				
DWPD ⁽⁶⁾	1	1	1			
UBER	< 1 sector per 10 ¹⁷ bits read	< 1 sector per 10 ¹⁷ bits read	< 1 sector per 10 ¹⁷ bits read			
MTBF (million hours)	2.0	2.0	2.0			
Limited Warranty (years)	5	5	5			
	Temperature					
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70			
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85			
	Physic	al Dimension				
Length (mm)	100.10	100.10	100.10			
Width (mm)	69.85	69.85	69.85			
Height (mm)	15.00	15.00	15.00			
Weight (g)	192	195	197			
Part Number						
Non-SED FW SED FW	D1808K02480GP025 12G00 D1808K02480GP225	D1808K02960GP021 T0200 D1808K02960GP221	D1808K021T92P022 T0400 D1808K021T92P222			
2ED FM	12G00	T0200	T0400			



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 Random Performance is based on FIO on Linux, 4K data size, QD=32, 8 worker.

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Form Factor		M.2 2280			
Capacity ⁽¹⁾	480GB	960GB	1920GB		
Interface	PCIe 4.0 x4	PCIe 4.0 x4	PCIe 4.0 x4		
NVMe	1.4	1.4	1.4		
NAND Flash	3D TLC	3D TLC	3D TLC		
	Performa				
Sequential Read(MB/s)	6,000	6,000	6,000		
Sequential Write(MB/s)	700	1,400	1,800		
4K Random Read(IOPS)	450K	7,400 750K	800K		
4K Random Write(IOPS)	25K	50K	60K		
	75	75	75		
Read Latency (Typ., µs)	40	35	35		
Write Latency (Typ., μs)	Power Cons				
A -4: (IAI)			0.0		
Active (W)	7.9	9.5	9.8		
Idle (W)	3.5	3.5	3.5		
	Endurance/	Reliability			
DWPD ⁽⁶⁾	1	1	1		
UBER	< 1 sector per 10 ¹⁷ bits read	< 1 sector per 10 ¹⁷ bits read	< 1 sector per 10 ¹⁷ bits read		
MTBF (million hours)	2.0	2.0	2.0		
Limited Warranty (years)	5	5	5		
Temperature					
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70		
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85		
Physical Dimension					
Length (mm)	80.00	80.00	80.00		
Width (mm)	22.00	22.00	22.00		
Height (mm)	4.08	4.08	4.08		
Weight (g)	11	11	11		
Part Number					
Non-SED FW SED FW	D1802K02480GP015 12G00 D1802K02480GP215 12G00	D1802K02960GP011 T0200 D1802K02960GP211 T0200	D1802K021T92P012 T0400 D1802K021T92P212 T0400		



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Form Factor	M.2 22110				
Capacity ⁽¹⁾	480GB	960GB	1920GB	3840GB	
Interface	PCIe 4.0 x4	PCIe 4.0 x4	PCIe 4.0 x4	PCIe 4.0 x4	
NVMe	1.4	1.4	1.4	1.4	
NAND Flash	3D TLC	3D TLC	3D TLC	3D TLC	
Performance ^(2,3,4)					
Sequential Read(MB/s)	6,000	6,000	6,000	3,700	
Sequential Write(MB/s)	700	1,400	1,800	1,700	
4K Random Read(IOPS)	450K	750K	800K	400K	
4K Random Write(IOPS)	25K	50K	60K	40K	
Read Latency (Typ., µs)	75	75	75	80	
Write Latency (Typ., µs)	40	35	35	25	
Power Consumption ⁽⁵⁾					
Active (W)	7.9	9.5	9.8	10.8	
Idle (W)	3.5	3.5	3.5	3.5	
	Endura	nce/Reliability			
DWPD ⁽⁶⁾	1	1	1	1	
UBER	< 1 sector per 10 ¹⁷ bits read				
MTBF (million hours)	2.0	2.0	2.0	2.0	
Limited Warranty (years)	5	5	5	5	
Temperature					
Operating Temp. (°C)	0 - 70	0 - 70	0 - 70	0 - 70	
Non-Operating Temp. (°C)	-40 - 85	-40 - 85	-40 - 85	-40 - 85	
Physical Dimension					
Length (mm)	110.00	110.00	110.00	110.00	
Width (mm)	22.00	22.00	22.00	22.00	
Height (mm)	4.08	4.08	4.08	4.08	
Weight (g)	13	13	13	15	
Part Number					
Non-SED FW SED FW	D1803K02480GP015 12G00 D1803K02480GP215 12G00	D1803K02960GP011 T0200 D1803K02960GP211 T0200	D1803K021T92P012 T0400 D1803K021T92P212 T0400	D1803K023T84P014 T0900 D1803K023T84P214 T0900	



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